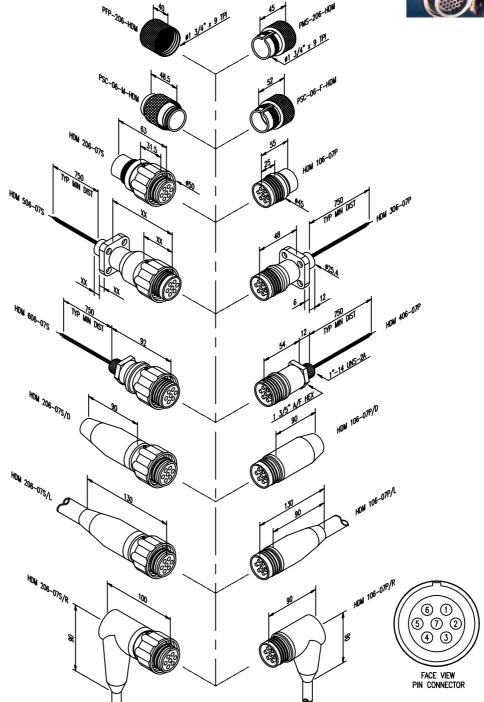


## HDM (Hydrobond Deck Mate) Surface Mateable Connector HDM\_06-07







Electrical and Environmental:

Pin Current Rating: 22 Amps Pin Voltage Rating: 1,500 V rms

Contact to Contact IR: >1,000 MOhms @ 1,000 V dc Contact to Body IR: >1,000 MOhms @ 1,000 V dc

Mated Depth Rating: 3,450 MSW Temperature Rating: -20 °C to +60 °C

Conductor Tail Size: 12 AWG Solder Bucket Size: 2.5 mm dia **Standard Material Specification:** 

Body: 316 Stainless Steel

Fix Ring: Aluminium Silicon Bronze

BackShell: N/A
Coax Pins: CZ121/Au
Coax Sockets: CZ121/Au
Least Materials Back

Insert Material: Peek Conductor Tails: Spec 44 X 1.0 m.

*O - Rings: NI70* 

Mechanical:

Lengths = mm
Threads = Inches
Mounting Detail:
See Mounting Detail
Section of Binder